PREPARED BY: DATE:			SPEC. No.	ED-94054D	-
m mituu Jun 18, 1996	SHAI	SP	ISSUE	June14, 1996	
APPROVED BY: DATE:	ELECTRONIC COMP	PONENTS	PAGE	10 Pages	
	GROUP SHARP COR		REPRESENT	ATIVE DIVISION	
J Yoshikawa June 12 1996	SPECIFICA'	TION	OPTO-ELEC	TRONIC DEVICES I	DIV.
DEVICE SE	PECIFICATION FOR	Business d	ealing name		
PHOTO	OCOUPLER	PC817X	PC817X6		
MODEL No		PC817X1 PC817X2 PC817X3			
P	C817	PC817X4 PC817X5		'	
These specification sheets in Please do not reproduce or a second contract of the seco	nclude materials protected und cause anyone to reproduce the			n ("Sharp").	
for any damage resulting from and the instructions including (Precautions) (1) This product is defined to the equipment of the equipment of the equipment of the equipment of the use of the equipment of the use of the equipment	s, as well as the precautions mom use of the product which doed in these specification sheets signed for use in the following Audio visual equipment ation equipment (Terminal) these Computers product in the above application be sure to observe the precaution area, such as fail-safe design a fifthe overall system and equipment product is used for equipment and precision, such as; control and safety equipment Gas leakage sensor breaker uipment	entioned below. Sees not comply we can the precause application areas. Home appliance Measuring equipons given in those and redundant dement, should be not which demandaire are Rescue and	Sharp assumes ith the absolute tions mentioned it is something the respective particular taken to ensure ds high reliability atomobile etc.)	no responsibility maximum ratings l below. paragraphs agraphs. g reliability ty and	
Space equipmen	tion and precision, such as; nt • Telecommunication equi		lines)		
(4) Please contact and	control equipment · Medical consult with a Sharp sales reparted three paragr	presentative if the	ere are any ques	stions	
3. Please contact and consult w	_		ons about this p	product.	
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CUSTOMER'S APPROVA	L	PRESENTEI BY	7.7	71	
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1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC817series.

2. Outline

Refer to the attached drawing No. CY6961K02.

3. Ratings and characteristics

Refer to the attached sheet, page 3 to 6.

4. Reliability

Refer to the attached sheet, page 7.

5. Incoming inspection

Refer to the attached sheet, page 8.

6. Supplement

- 6.1 Isolation voltage shall be measured in the following method.
- (1) Short between anode to cathode on the primary side and between collector to emitter on the secondary side.
- (2) The dielectric withstand tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.
 (It is recommended that the isolation voltage be measured in insulation oil.)

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6.2 Business dealing name

("O" mark indicates business dealing name of ordered product)

Ordered product	Business dealing name	Rank mark	Ic (mA)
	PC817X	A, B, C, D or no mark	2.5 to 30
	PC817X1	A	4.0 to 8.0
	PC817X2	В	6.5 to 13
	PC817X3	С	10 to 20
	PC817X4	D	15 to 30
	PC817X5	A or B	4.0 to 13
	PC817X6	B or C	6.5 to 20
	PC817X7	C or D	10 to 30
	PC817X8	A, B or C	4.0 to 20
	PC817X9	B, C or D	6.5 to 30
	PC817X0	A, B, C or D	4.0 to 30

Test	
conditions	
I _F =5mA	
-	
V_{CE} =5 V	
CD	
Ta=25℃	
1200	

6.3 This Model is approved by UL.

Approved Model No.: PC817

UL file No.: E64380

6.4 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

7. Notes

Refer to the attached sheet-1-1, 2.

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3. Ratings and characteristics

3.1 Absolute maximum ratings

Ta=25℃

	Parameter	Symbol	Rating	Unit
	*l Forward current	I _F	50	mA
Innut	*2 Peak forward current	I_{FM}	1	A
Input	Reverse voltage	V_R	6	V
	*l Power dissipation	P	70	mW
	Collector-emitter voltage	V _{CEO}	35	V
O	Emitter-collector voltage	V_{ECO}	6	V
Output	Collector current	I c	50	mA
	*l Collector power dissipation	Pc	150	mW
	*l Total power dissipation	Ptot	200	mW
· · · · · · · · · · · · · · · · · · ·	*3 Isolation voltage	Viso	5	kVrms
	Operating temperature	Topr	-30 to +100	C
	Storage temperature	Tstg	-55 to +125	Ç
	*4 Soldering temperature	Tsol	260	Ç

^{*1} The derating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4.

^{*2} Pulse width \leq 100 μ s, Duty ratio : 0.001 (Refer to Fig. 5)

^{*3} AC for 1 min, 40 to 60%RH

^{*4} For 10 s

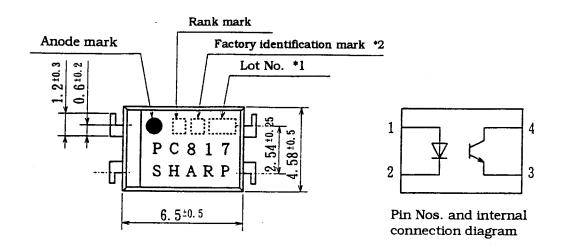
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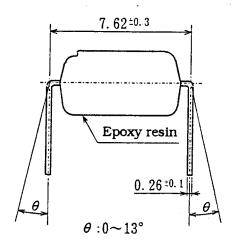
3.2 Electro-optical characteristics

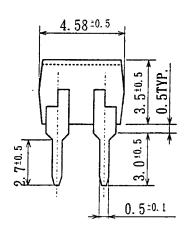
Ta=25℃

	Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
	Forward voltage	$V_{\rm F}$	I _F =20mA	-	1.2	1.4	v
Input	Peak forward voltage	V_{FM}	I _{FM} =0.5A	-	-	3.0	V
прис	Reverse current	I _R	V _R =4V	-	-	10	μΑ
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	pF
	Dark current	I _{CEO}	V _{CE} =20V, I _F =0	-	-	100	nA
Output	Collector-emitter breakdown voltage	BV _{CEO}	Ic=0.1 mA I _F =0	35	-	-	V
	Emitter-collector breakdown voltage	$\mathrm{BV}_{\mathrm{ECO}}$	$I_{E}=10 \ \mu A, \ I_{F}=0$	6	-	-	V
	Collector current	Ic	I _F =5mA, V _{CE} =5V	2.5	-	30	mA
	Collector-emitter saturation voltage	$ m V_{CE(sat)}$	I _F =20mA Ic=1mA	-	0.1	0.2	v
Transfer charac-	Isolation resistance	R _{ISO}	DC500V 40 to 60%RH	5×10 ¹⁰	1011	-	Ω
teristics	Floating capacitance	Cf	V=0, f=1MHz	-	0.6	1.0	pF
	Cut-off frequency	fc	V_{CE} =5V, Ic=2mA R _L =100 Ω , -3dB	-	80	-	kHz
	Rise time	tr	V _{CE} =2V Ic=2mA	-	4	18	μS
	Fall time	tf	$R_L=100 \Omega$	-	3	18	μS

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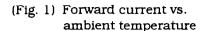


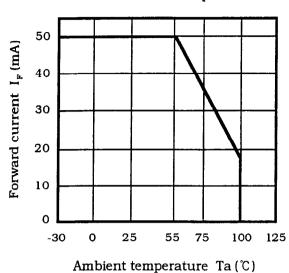


- *1) 2-digit number shall be marked according to DIN standard.
- *2) Factory identification mark shall be or shall not be marked.
- *3) Marking is laser marking

UNIT: 1/1 mm		
Name	PC817 Outline Dimensions (Business dealing name : PC817X)	
Drawing No.	CY6961K02	

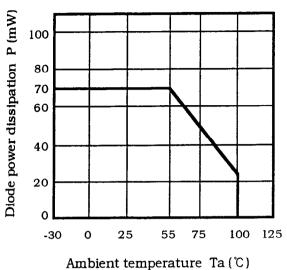
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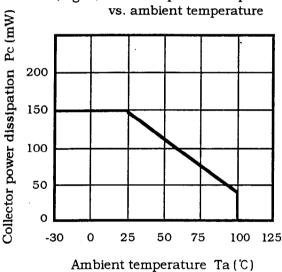


vs. ambient temperature

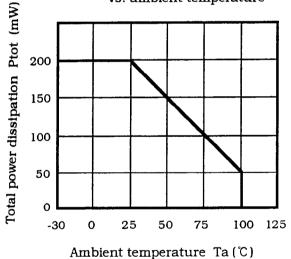
(Fig. 2) Diode power dissipation



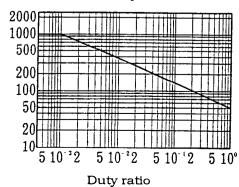
(Fig. 3) Collector power dissipation



(Fig. 4) Total power dissipation vs. ambient temperature



(Fig. 5) Peak forward current vs. duty ratio



Peak forward current I_{FM} (mA)

Pulse width $\leq 100 \, \mu \, s$ Ta=25℃

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4. Reliability

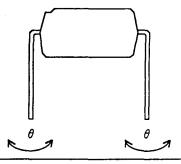
The reliability of products shall be satisfied with items listed below.

Confidence level: 90% LTPD: 10%/20%

Test Items	Test Conditions	Failure Judgement Criteria	Samples (n) Defective(C)
Solderability *2	230℃, 5 s		n=11, C=0
Soldering heat	260℃, 10 s		n=11, C=0
Terminal strength (Tension)	Weight : 5N 5 s/each terminal	$V_F>U\times1.2$	n=11, C=0
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	I _R >U×2	n=11, C=0
Mechanical shock	15000m/s^2 , 0.5ms $3 \text{ times}/\pm X$, $\pm Y$, $\pm Z$ direction	$I_{CEO} > U \times 2$ $I_{C} < L \times 0.7$	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4min 200m/s ² 4 times/ X, Y, Z direction	$ m V_{CE(sat)} > U imes 1.2$	n=11, C=0
Temperature cycling	1 cycle -55°C to +125°C (30min) (30min) 20 cycles test	Y. V.	n=22,C=0
High temp. and high humidity storage	+60°C, 90%RH, 1000h	U : Upper specification limit	n=22,C=0
High temp. storage	+125℃, 1000h	L: Lower	n=22,C=0
Low temp. storage	-55℃, 1000h	specification limit	n=22,C=0
Operation life	I _F =50mA, Ptot=200mW Ta=25℃, 1000h		n=22,C=0

^{*1} Test method, conforms to JIS C 7021.

- *2 Solder shall adhere at the area of 95% or more of immersed portion of lead and pin hole or other holes shall not be concentrated on one portion.
- *3 Terminal bending direction is shown below.



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- 5. Incoming inspection
 - 5.1 Inspection items
 - (1) Electrical characteristics

$$V_{F}$$
, I_{R} , I_{CEO} , $V_{CE(sat)}$, Ic, R_{ISO} , Viso

- (2) Appearance
- 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL (%)
Major defect	Electrical characteristics Unreadable marking	0.1
Minor defect	Appearance defect except the above mentioned.	0.4

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PC817X Attach
sheet-1-1

Precautions for Photocouplers

1 For cleaning

(2) Ultrasonic cleaning: The affect to device by ultrasonic cleaning is different

by cleaning bath size, ultrasonic power

output, cleaning time, PWB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting

the ultrasonic cleaning.

Applicable solvent: Ethyl alcohol, Methyl alcohol

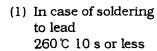
Freon TE · TF, Diflon-solvent S3-E

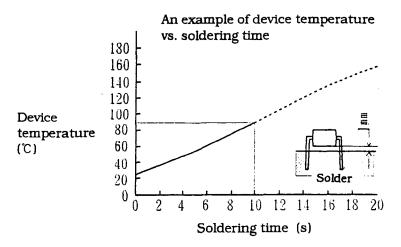
Please refrain form using Chloro Fluoro Carbon type solvent to clean device as much as possible since it is internationally restricted to protect the ozonosphere. Before you use alternative solvent you are requested to confirm that it does not attack package resin.

2. The LED used in the Photocoupler generally decreases the light emission power by operation. In case of long operation time, please design the circuit with considering the degradation of the light emission power of the LED. (50%/5years)

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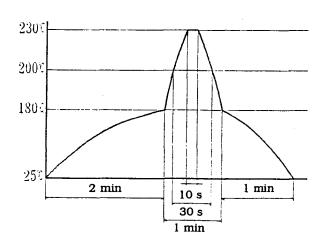
3. Precautions for Soldering Photocouplers





(2) If solder reflow:

It is recommended that only one soldering be done at the temperature and the time within the temperature profile as shown in the figure.



(3) Other precautions

An infrared lamp used to heat up for soldering may cause a localized temperature rise in the resin. So keep the package temperature within that specified in Item (2). Also avoid immersing the resin part in the solder.

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